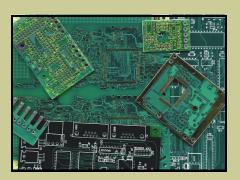


Since 1995, Global Resources, Local Support



When you need quality Printed Circuit Boards ...

To Spec

On Time

On Budget





Count on Optima Technology Associates to meet your requirements



Optima Technology Associates, Inc. was founded in 1995 to provide complete electronic contract manufacturing services from design through assembly and fulfillment. Included in our core operations is one of the industry's best, most reliable, and customer friendly sources of rigid printed circuit boards.

Consider the convenience of having all of your electronic needs handled by a single source with a strong commitment to quality and customer satisfaction. Whether your need is prototype, medium or high volume production, Optima is driven to always deliver high quality goods and services, on time. Our goal—better value from your electronic supplier to strengthen your strategic position.

Located in Lewisberry, PA and New Delhi, India, we specialize in providing local support coupled with cost-effective pricing via off-shore manufacturing through our ISO Approved facilities.

From concept to production, Optima is your one stop for printed circuit boards.

Capabilities

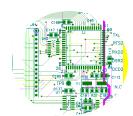
- Single-sided / double-side (rigid), FR4 & Metal Core
- Multi-layer FR4 up to 10 layers (rigid)
- Buried vias
- Controlled impedance
- Materials available: CEM1, FR4, FR5, Teflon, Getek, Microwave/High Frequency (Rogers), Polyimide, etc.
- Electroless nickel/immersion gold, immersion silver, immersion tin, HASL, SMOBC Finishes

To Order Call: 1 717 932 5877, or email: optima@optimatech.net

Processes

- IPC 600 Class 2 (Standard)
- IPC 600 Class 3 (Available, as required)
- IPC 6012 / MIL STDs (Available, as required)
- Material thickess 0.010 to 0.125
- SMOBC, HAL, Tin/Lead Reflow, RoHS Compliance
- LPI, Wet Film, Dry Film soldermasks in a variety of colors
- Various silkscreen colors
- Edge tab gold plating
- Scoring, routing
- 100% bare board testing (including flying probe)

Services



- Design review check
- Photo Plotting / Gerber plot review
- Blanket orders, split deliveries
- Quick turn prototypes to production
- PCB design & layout
- SMT & TH assembly via in-house operations



PCB Technology Summary

Build Specification		Plating Aspect Ratio	
IPC Class (I, II, or III)	Class II, III	Standard (Ratio #)	1:04
UL Registration (UL 94V0 or others)	UL796 & UI 94VO	Extended (Ratio #)	1:06
Layer Count		Soldermask	
# of layers (min/max)	1-10 Layers	Soldermask Type (LPI, Dry film, etc.)	LPI
Board Sizes	o _ayo.o	Minimum dam (in.)	5 mil
Maximum dimensions (in.)	16" x 20"	Soldermask Registration	
Board Thickness	10 / 20	Standard Tolerance (in.)	+/-0.004"
Board thickness range (in.)	0.016 -0.125"	Extended Tolerance (in.)	'+/-0.003"
Thickness tolerance (%)	7-10%	Soldemask Image	
Core thickness range (in.)	0.006- 0.031"	•	
Warp & Twist	0.000 0.001	Image Process (Photo, Laser, etc.)	Photo
Maximum board warp (%)	<1.0%	Silkscreen	
PCB Edge to conductor	11.070	Text Height (in.)	0.035"
PCB Edge to conductor (in.)	0.008"	Stroke Width (in.)	0.006"
Laminate Materials	0.000	Colors	White, Black
External (FR4, FR406, RCC,		Location accuracy (in.)	+/-0.010"
etc.)	FR4, FR406	VIAs (Smallest finished dia.)	
Internal (FR4, FR406, RCC, etc.)	FR4, FR406	Drilled (in.)	0.010"
Material Properties	11(1,11(100	Buried (in.)	0.012"
Dk (Dielectric Constant #)	4.2 -4.6	Via plugging	
Tg (Glass Transition in deg. C)	130-170	Percent plugged (%)	A/R
Surface Finish Capabilities	100 110	VIA Pad Size	
HASL (Y/N)	YES	External (in.)	0.020"
ENIG (Y/N)	YES	Internal (in.)	0.024"
Immersion silver (Y/N)	YES	Routing	
Other finishes (Types)	Immersion Tin	Tolerance (in.)	+/-0.005"
Finish Thickness	minicision ini	V-score	
HASL (in.)	0.003-0.010"	Tolerance (in.)	+/- 0.004"
ENIG (in.)	2-3 micro inches	PCB Test	
Immersion silver (in.)	6-18 micro inches	Net List Test (% coverage)	100%
illilleision silvei (ili.)	Tin 32-48 micro	IPC-9252, Class III (Y/N)	YES
Other finishes (Type: in.)	inches	Other Tests (Type/% coverage)	
Lines/Spaces			40
External minimum (in./in.)	0.006"	Impedance test (ohms/tolerance%)	10
Internal minimum (in./in.)	0.006"	Test Point Spacing	40 "
Copper Thickness		Spacing (in.)	40 mil
External range (oz)	0.5 - 2 Oz	Delivery Lead-time	- 46 :
Internal range (oz)	1 -2 Oz	Pre-production (days)	5 - 10days
Internal Power range (oz)	1- 2 Oz	Production (days)	10-15 days
Hole Plating		On-time Delivery	0001
Minimum plating (in.) Non-plated hole size tolerance	1 mil	OTD (% on-time)	99%

+/-0.003" +/-0.003

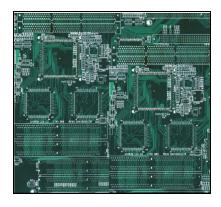


Plated hole size tolerance (in.)



Certifications & Memberships

- UL 94 V0 listed
- ISO 9001:2000
- RoHS per Eu Directive 2002/95/EC
- Indian Printed Circuit Board Association (INBA)
- Indo American Chamber of Commerce (IACC)
- SAP Enabled (Customized ERP)



Data Type & Formats

- Gerber (.gbr, 274X preferred, 274D supported
- AutoCAD (.dwg, .dxf)
- Excellon (.drl)



Getting Started

- Gerber data for all artwork layers
- Aperature list of all layers
- Drill file in gerber or Excellon format
- Fabrication drawing (dimensions & tolerances, datums, hole coding, finished thickness, hole size reference, finished size, tolerance, & plating)
- Notes (material, mask type / color, silk screen type / color, plating thickness & special requirements)
- Fabrication standards & specifications

